

# **PMBFJ111**; **PMBFJ112**; PMBFJ113 N-channel junction FETs

Rev. 4 — 20 September 2011

**Product data sheet** 

# **Product profile**

#### 1.1 General description

Symmetrical N-channel junction FETs in a SOT23 package.

#### 1.2 Features and benefits

- High-speed switching
- Interchangeability of drain and source connections
- Low  $R_{DSon}$  at zero gate voltage (< 30  $\Omega$  for PMBFJ111).

#### 1.3 Applications

- Analog switches
- Choppers
- Commutators
- Multiplexers
- Thin and thick film hybrids.

# **Pinning information**

Table 1. **Pinning** 

Pin	Description <sup>[1]</sup>	Simplified outline	Symbol
1	drain		
2	source	3	
3	gate	1 2	3 → 1 2 sym053

<sup>[1]</sup> Drain and source are interchangeable.



# 3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
PMBFJ111	-	plastic surface mounted package; 3 leads	SOT23		
PMBFJ112					
PMBFJ113					

# 4. Marking

Table 3. Marking

Type number	Marking code <sup>[1]</sup>
PMBFJ111	41*
PMBFJ112	42*
PMBFJ113	47*

<sup>[1] \* =</sup> p: Made in Hong Kong

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage (DC)		-	±40	V
$V_{GSO}$	gate-source voltage		-	-40	V
$V_{GDO}$	gate-drain voltage		-	-40	V
I <sub>G</sub>	forward gate current (DC)		-	50	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	<u>[1]</u> _	300	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		-	150	°C

<sup>[1]</sup> Mounted on a ceramic substrate, 8 mm  $\times$  10 mm  $\times$  0.7 mm.

#### 6. Thermal characteristics

Table 5. Thermal characteristics

 $T_j = P (R_{th(j-t)} + R_{th(t-s)} + R_{th(s-a)}) + T_{amb}.$ 

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient		<u>[1]</u> 430	K/W
	thermal resistance from junction to ambient		<sup>[2]</sup> 500	K/W

<sup>[1]</sup> Mounted on a ceramic substrate, 8 mm  $\times$  10 mm  $\times$  0.7 mm.

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<sup>\* =</sup> t: Made in Malaysia

<sup>\* =</sup> W: Made in China

<sup>[2]</sup> Mounted on printed circuit board.

# 7. Static characteristics

Table 6. Static characteristics

 $T_i = 25 \, ^{\circ}\text{C}$ .

., – 20 0.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>GSS</sub>	gate-source leakage current	$V_{GS} = -15 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	-1	nΑ
I <sub>DSS</sub>	drain-source leakage current					
	PMBFJ111	$V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$	20	-	-	mΑ
	PMBFJ112	$V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$	5	-	-	mΑ
	PMBFJ113	$V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$	2	-	-	mΑ
$V_{(BR)GSS}$	gate-source breakdown voltage	$I_G = -1 \mu A; V_{DS} = 0 V$	-40	-	-	V
$V_{GSoff}$	gate-source cut-off voltage					
	PMBFJ111	$I_D = 1 \mu A; V_{DS} = 5 V$	-10	-	-3	V
	PMBFJ112	$I_D = 1 \mu A; V_{DS} = 5 V$	-5	-	-1	V
	PMBFJ113	$I_D = 1 \mu A; V_{DS} = 5 V$	-3	-	-0.5	V
R <sub>DSon</sub>	drain-source on-state resistance					
	PMBFJ111	$V_{GS} = 0 \text{ V}; V_{DS} = 0.1 \text{ V}$	-	-	30	Ω
	PMBFJ112	$V_{GS} = 0 \text{ V}; V_{DS} = 0.1 \text{ V}$	-	-	50	Ω
	PMBFJ113	$V_{GS} = 0 \text{ V}; V_{DS} = 0.1 \text{ V}$	-	-	100	Ω

# 8. Dynamic characteristics

Table 7. Dynamic characteristics

	•					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$C_{\text{iss}}$	input capacitance	$V_{DS} = 0 \text{ V}; V_{GS} = -10 \text{ V}; f = 1 \text{ MHz}$	-	6	-	pF
		$V_{DS} = 0 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$	-	22	28	pF
C <sub>rss</sub>	feedback capacitance		-	3	-	pF
Switching	g times; see Figure 2					
t <sub>r</sub>	rise time		<u>[1]</u> -	6	-	ns
t <sub>on</sub>	turn-on time		<u>[1]</u> -	13	-	ns
t <sub>f</sub>	fall time		<u>[1]</u> -	15	-	ns
t <sub>off</sub>	turn-off time		<u>[1]</u> _	35	-	ns

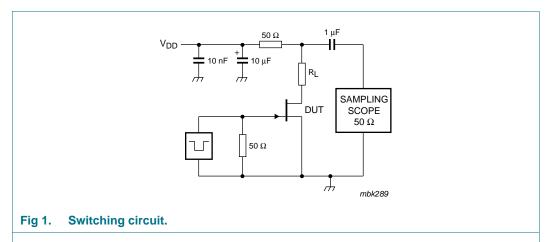
<sup>[1]</sup> Test conditions for switching times are as follows:

 $V_{DD} = 10 \text{ V}, V_{GS} = 0 \text{ V to } V_{GSoff} \text{ (all types)};$ 

 $V_{GSoff} = -12 \text{ V}, R_L = 750 \Omega \text{ (PMBFJ111)};$ 

 $V_{GSoff}$  = -7 V,  $R_L$  = 1550  $\Omega$  (PMBFJ112);

 $\mbox{V}_{\mbox{GSoff}}$  = –5 V,  $\mbox{R}_{\mbox{L}}$  = 3150  $\Omega$  (PMBFJ113).



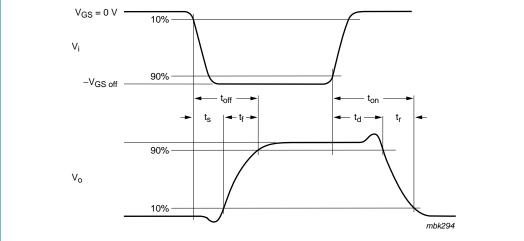


Fig 2. Input and output waveforms.

# 9. Package outline

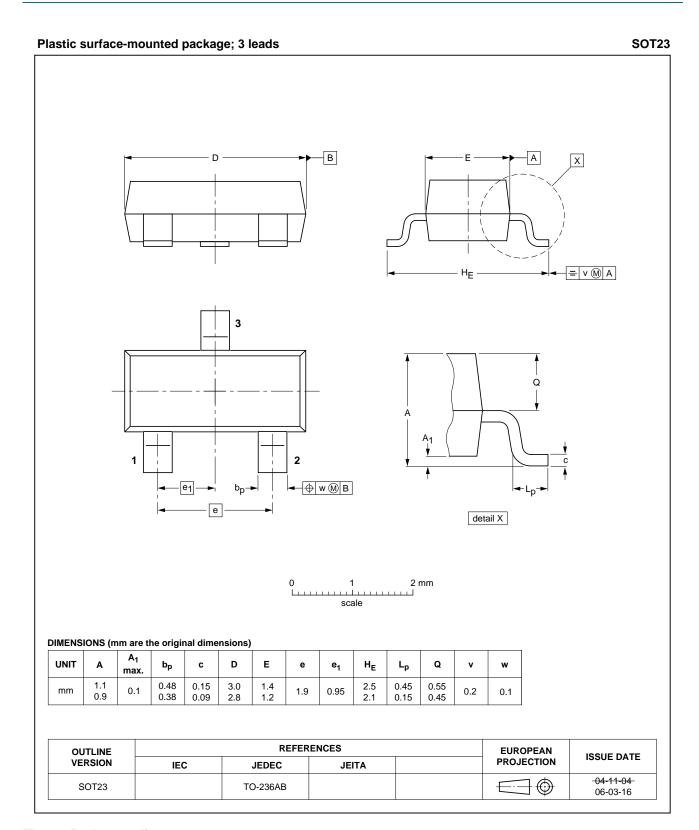


Fig 3. Package outline.

# 10. Revision history

#### Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBFJ111_112_113 v.4	20110920	Product data sheet	-	PMBFJ111_112_113 v.3
Modifications:	guidelines of Legal texts	of NXP Semiconductors.	ne new company r	comply with the new identity name where appropriate. atest version.
PMBFJ111_112_113 v.3 (9397 750 13402)	20040804	Product data sheet	-	PMBFJ111_112_113_CNV v.2
PMBFJ111_112_113_CNV v.2	19971201	Product specification	-	-

# 11. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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